

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

Notification# 20221018005.0 Datasheet for CDx4HC240, CDx4HCT240, CD74HC241, CDx4HCT241, CDx4HC244, CDx4HCT244, CDx4HC374, CDx4HC534, CDx4HCT534, CDx4HC564, CDx4HCT564 and CDx4HC(T)541 **Information Only**

Date: October 19, 2022

TOKYO ELECTRON DEVICE (DSTR) PCN

Dear Customer:

This is an information-only announcement of a change to the datasheet for a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN team (PCN www admin team@list.ti.com).

Sincerely,

PCN Team SC Business Services

Information Only Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
CD74HC541PW	null
CD74HC541M96	null
CD74HC244M96	null
CD74HC564M96	null
CD74HC564M	null

Technical details of this Product Change follow on the next page(s).

No	tificat	tion Number:	202210			Notification I			October 19	
Titl	Datasheet for CDx4HC73, CD74HCT73, CDx4HC112, CDx4HCT112, CDx4HC688, CDx4HCT688, CDx4HC374, CDx4HC534, CDx4HCT534, CDx4HC564, CDx4HCT564 and CDx4HC(T)541									
			PCN Manage	er			De	pt:	Quality	Services
		Туре:								
П		embly Site		Ш	Design		ПП	Wa	afer Bump Sit	te
Ī	Assembly Process Design Water Bump M Wafer B									
		embly Materials	}			er change		_	afer Bump Pr	
☐ Mechanical Specification					Test Site			Wafer Fab Site		2
Packing/Shipping/Labeling				Test Proc	ess		Wafer Fab Materials		erials	
	□ Wafer Fab Process						cess			
				N	otificatio	n Details				
De	script	tion of Change	e:							
The	Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details. CD54HC240, CD74HC241, CD54HC244 CD74HC244, CD54HCT240, CD74HCT241, CD54HCT241 CD74HCT241, CD54HCT241, CD54HCT241 SCHS167G - NOVEMBER 1998 - REVISED OCTOBER 2022									
9						n G (October 202				Page
•						(82 to 122.7); N (6				
	to 13	31.8)								4
	CD54HC374, CD74HC374, CD54HCT374, CD54HC574, CD74HC574, CD54HCT574, CD74HC574, CD74HC574, CD74HC574, CD74HCT574, CD74HCT574 SCHS183E – NOVEMBER 1998 – REVISED OCTOBER 2022 Changes from Revision D (January 2022) to Revision E (October 2022) Page									
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CDx4HCT564		
CDx4HC(T)541	SCHS189D	SCHS189E

These changes may be reviewed at the datasheet links provided.

https://www.ti.com/product/CD54HC240 https://www.ti.com/product/CD54HC374 https://www.ti.com/product/CD54HC534 https://www.ti.com/product/CD54HC541

Error! Bookmark not defined.

Reason for Change:

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this notification:

Product Affected:

CD74HC240E	CD74HC540E	CD74HCT240E	CD74HCT540M
CD74HC240M	CD74HC540M	CD74HCT240EE4	CD74HCT540M96
CD74HC240M96	CD74HC540M96	CD74HCT240PW	CD74HCT541E
CD74HC241E	CD74HC541E	CD74HCT240PWR	CD74HCT541M
CD74HC241M	CD74HC541EE4	CD74HCT240PWT	CD74HCT541M96
CD74HC241M96	CD74HC541M	CD74HCT241E	CD74HCT541M96E4
CD74HC244E	CD74HC541M96	CD74HCT241M	CD74HCT541M96G4
CD74HC244EE4	CD74HC541M96G4	CD74HCT241M96	CD74HCT564E
CD74HC244M	CD74HC541PW	CD74HCT244E	CD74HCT564M
CD74HC244M96	CD74HC541PWR	CD74HCT244M	CD74HCT564MG4
CD74HC244M96E4	CD74HC564DWR	CD74HCT244M96	CD74HCT574E
CD74HC244M96G4	CD74HC564E	CD74HCT374E	CD74HCT574M
CD74HC374E	CD74HC564M	CD74HCT374EE4	CD74HCT574M96
CD74HC374M	CD74HC564M96	CD74HCT374M	CD74HCT574ME4
CD74HC374M96	CD74HC574E	CD74HCT374M96	CD74HCT574PWR
CD74HC374M96E4	CD74HC574M	CD74HCT534E	SN74HC244N-P2
CD74HC534E	CD74HC574M96	CD74HCT540E	

For questions regarding this notice, e-mails can be sent to the contact shown below or your local Field Sales Representative.

Location	E-Mail
WW PCN Team	PCN www admin team@list.ti.com

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